

INTERNATIONAL GEMOLOGICAL INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

August 22, 2023					
IGI Report Number	LG596337863				
Description	LABORATORY GROWN DIAMOND				
Shape and Cutting Style	ROUND BRILLIANT				
Measurements	7.05 - 7.08 X 4.41 MM				
GRADING RESULTS					
Carat Weight	1.37 CARAT				
Color Grade	D				
Clarity Grade	VVS 2				
Cut Grade	IDEAL				
ADDITIONAL GRADING INFORMATION					
Polish	EXCELLENT				

Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	1571 LG596337863

Comments: As Grown - No indication of post-growth treatment.

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

LABORATORY GROWN DIAMOND REPORT

LG596337863 Report verification at igi.org

57%

Pointed

35.9°

40.8°

62.5%

PROPORTIONS

15.5%

43%

CLARITY CHARACTERISTICS

KEY TO SYMBOLS

Red symbols indicate internal characteristics.

Green symbols indicate external characteristics.

 \checkmark

Medium To

Slightly Thick (Faceted)

LABORATORY GROWN DIAMOND REPORT

GRADING SCALES

CLARITY

IF	VVS ¹⁻²	VS ¹⁻²	SI ¹⁻²	l ¹⁻³
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

COLOR

D	Е	F	G	Н	I	J	Faint	Very Light	Light
D	Е	F	G	Н	Ι	J	Faint	Very Light	Ligh

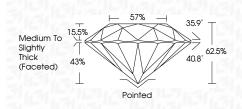


Sample Image Used

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